Better End-Cap Processing for Oxidation-Resistant Polyimides

Cross-linking in an inert atmosphere (as opposed to air) yields better results.

John H. Glenn Research Center, Cleveland, Ohio

A class of end-cap compounds that increase the thermo-oxidative stability of polyimides of the polymerization of monomeric reactants (PMR) type has been extended. In addition, an improved processing protocol for this class of end-cap compounds has been invented.

The class of end-cap compounds was described in “End Caps for More Thermo-Oxidative Stability in Polyimides” (LEW-17012), NASA Tech Briefs, Vol. 25, No. 10 (October 2001), page 32. To recapitulate: PMR polyimides are often used as matrix resins of high-temperature-resistant composite materials. These end-cap compounds are intended to supplant the norbornene end cap (NE) compound that, heretofore, has served to limit molecular weights during oligomerization and, at high temperatures, to form cross-links that become parts of stable network molecular structures. NE has been important to processability of high-temperature resins because (1) in limiting molecular weights, it enables resins to flow more readily for processing and (2) it does not give off volatile byproducts during final cure and, therefore, enables the production of void-free composite parts. However, with respect to ability of addition polymers to resist oxidation at high temperature, NE has been a “weak link.” Consequently, for example, in order to enable times or more than a thousand times as great as that generated by a single-indicator reporter molecule. By increasing signal-to-noise ratios relative to those available from prior reporter compounds, the invention of these reporter compounds can be expected to facilitate the detection of very small amounts of target compounds—for example, particular genes in blood samples.

This work was done by Wenhong Fan, Jun Li, and Jie Han of Ames Research Center. Further information is contained in a TSP (see page 1).

Inquiries concerning rights for the commercial use of this invention should be addressed to the Patent Counsel, Ames Research Center, (650) 604-5104. Refer to ARC-14908-1.

End Caps of These Molecular Structures are alternatives to previously reported end caps for increasing the thermo-oxidative stability of polyimides. R1 through R4 can be any of a variety of substituents (for example, alkyl, alkoxy, aryl, halogen, or nitro), the inclusion of which reduces the cross-linking temperature.

Inquiries concerning rights for the commercial use of this invention should be addressed to NASA Glenn Research Center, Commercial Technology Office, Attn: Steve Fedor, Mail Stop 4-8, 21000 Brookpark Road, Cleveland, Ohio 44135. Refer to LEW-17429.